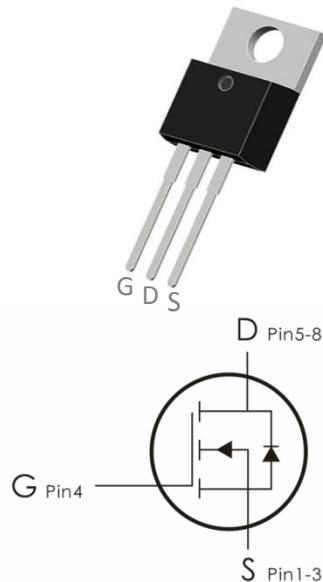


## Description:

This N-Channel MOSFET uses advanced trench technology and design to provide excellent  $R_{DS(on)}$  with low gate charge. It can be used in a wide variety of applications.

## Features:

- 1)  $V_{DS}=60V, I_D=130A, R_{DS(on)}<3.5m\Omega @V_{GS}=10V$
- 2) Low gate charge.
- 3) Green device available.
- 4) Advanced high cell density trench technology for ultra  $R_{DS(on)}$ .
- 5) Excellent package for good heat dissipation.



## Absolute Maximum Ratings: ( $T_c=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Ratings	Units
$V_{DS}$	Drain-Source Voltage	60	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Continuous Drain Current- $TC=25^\circ C$ <sup>1</sup>	130	A
	Continuous Drain Current- $TC=100^\circ C$	---	
	Pulsed Drain Current <sup>2</sup>	390	
$E_{AS}$	Single Pulse Avalanche Energy <sup>5</sup>	80	mJ
$P_D$	Power Dissipation <sup>3</sup>	140	W
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55 to +150	$^\circ C$

## Thermal Characteristics:

Symbol	Parameter	Max	Units
$R_{eJC}$	Thermal Resistance,Junction to Case	0.89	$^\circ C/W$
$R_{eJA}$	Thermal Resistance Junction to mbient <sup>4</sup>	62	$^\circ C/W$

**Electrical Characteristics:** ( $T_C=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>Off Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}, I_D=250 \mu\text{A}$	60	---	---	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{GS}=0\text{V}, V_{DS}=60\text{V}$	---	---	1	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Source Leakage Current	$V_{GS}=\pm 20\text{V}, V_{DS}=0\text{A}$	---	---	$\pm 100$	nA
<b>On Characteristics<sup>3</sup></b>						
$V_{GS(\text{th})}$	GATE-Source Threshold Voltage	$V_{GS}=V_{DS}, I_D=250 \mu\text{A}$	1	---	2.5	V
$R_{DS(\text{ON})}$	Drain-Source On Resistance	$V_{GS}=10\text{V}, I_D=20\text{A}$	---	3	3.5	$\text{m}\Omega$
		$V_{GS}=4.5\text{V}, I_D=10\text{A}$	---	3.5	4.5	
<b>Dynamic Characteristics<sup>4</sup></b>						
$C_{iss}$	Input Capacitance	$V_{DS}=25\text{V}, V_{GS}=0\text{V}, f=100\text{KHz}$	---	5377	---	pF
$C_{oss}$	Output Capacitance		---	1666	---	
$C_{rss}$	Reverse Transfer Capacitance		---	77.7	---	
<b>Switching Characteristics<sup>4</sup></b>						
$t_{d(on)}$	Turn-On Delay Time	$V_{DD}=30\text{V}, I_D=25\text{A}, R_G=2\Omega$ $V_{GS}=10\text{V}$	---	22.5	---	ns
$t_r$	Rise Time		---	6.7	---	ns
$t_{d(off)}$	Turn-Off Delay Time		---	80.3	---	ns
$t_f$	Fall Time		---	26.8	---	ns
$Q_g$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=30\text{V}, I_D=25\text{A}$	---	66.1	---	nC
$Q_{gs}$	Gate-Source Charge		---	10.7	---	nC
$Q_{gd}$	Gate-Drain "Miller" Charge		---	10.9	---	nC
<b>Drain-Source Diode Characteristics</b>						
Symbol	Parameter	Conditions	Min	Typ	Max	Units
$V_{SD}$	Source-Drain Diode Forward Voltage	$V_{GS}=0\text{V}, I_S=20\text{A}$	---	---	1.3	V



<b>LS</b>	Continuous Source Current	VGS\<Vth	---	---	130	<b>A</b>
<b>LSp</b>	Pulsed Source Current		---	---	390	
<b>Trr</b>	Reverse Recovery Time	I <sub>S</sub> =25 A, di/dt=100 A/μs	---	68.3	---	NS
<b>Qrr</b>	Reverse Recovery Charge		---	73	---	NC

**Notes:**

- 1) Calculated continuous current based on maximum allowable junction temperature.
- 2) Repetitive rating; pulse width limited by max. junction temperature.
- 3) Pd is based on max. junction temperature, using junction-case thermal resistance.
- 4) The value of R<sub>θJA</sub> is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T<sub>a</sub>=25 °C.
- 5) V<sub>DD</sub>=50 V, R<sub>G</sub>=25 Ω, L=0.3 mH, starting T<sub>j</sub>=25 °C.

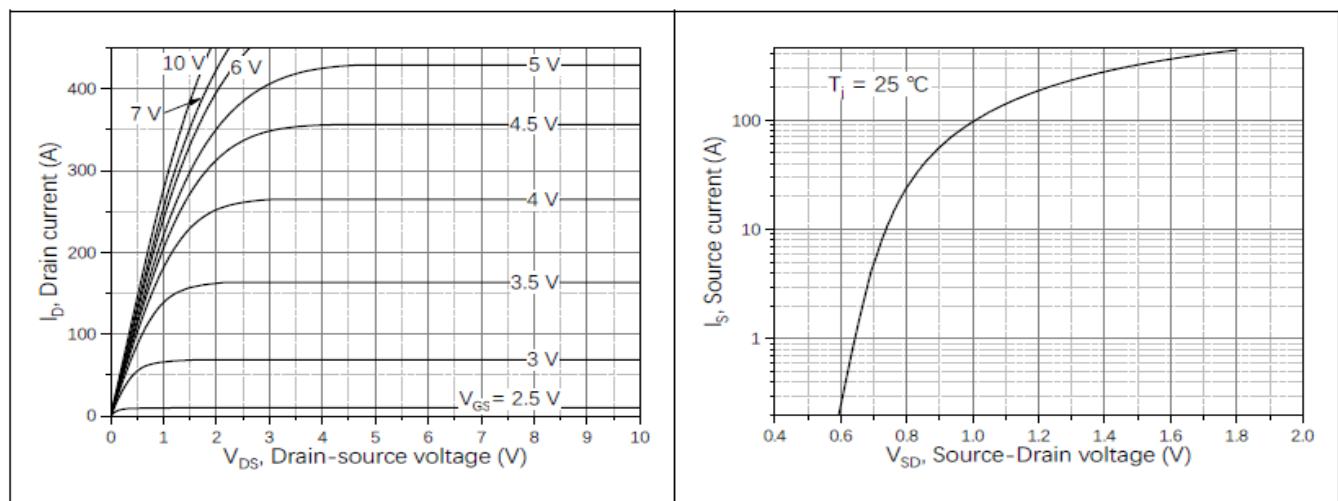
**Typical Characteristics:** (T<sub>c</sub>=25°C unless otherwise noted)

Figure 1, Typ. output characteristics

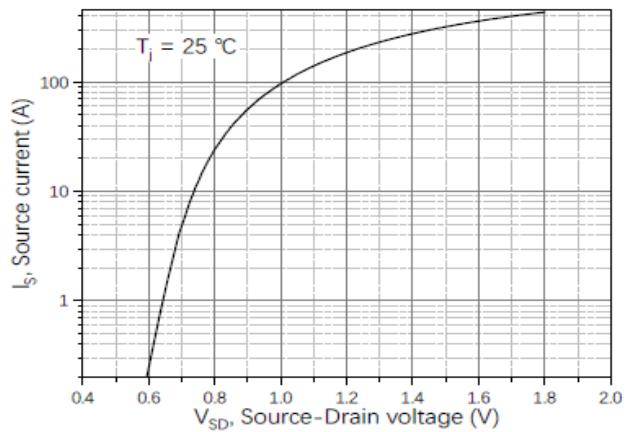


Figure 2, Typ. transfer characteristics

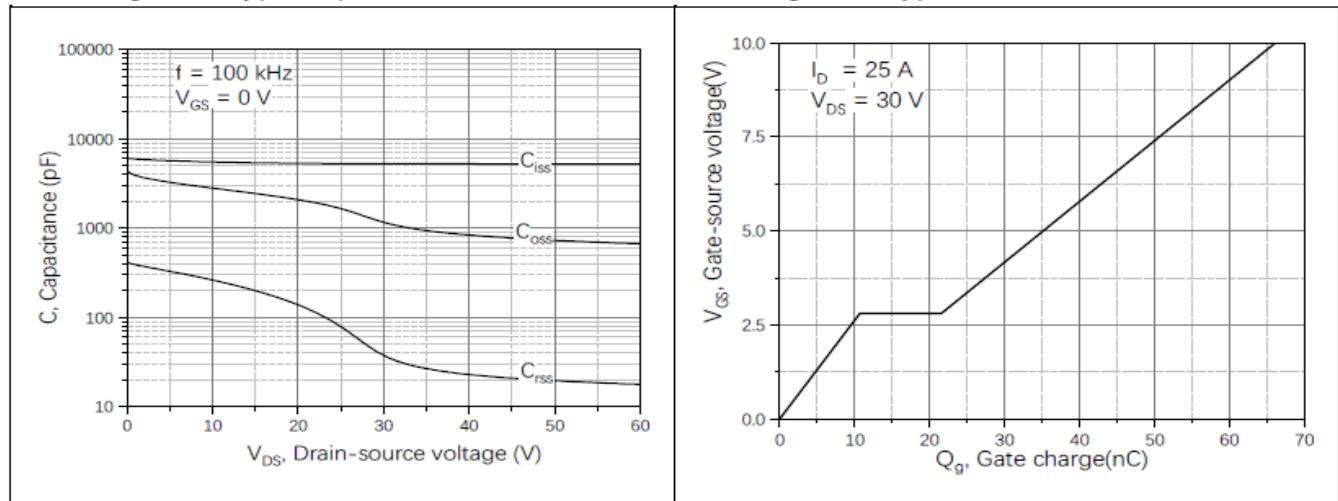


Figure 3, Typ. capacitances

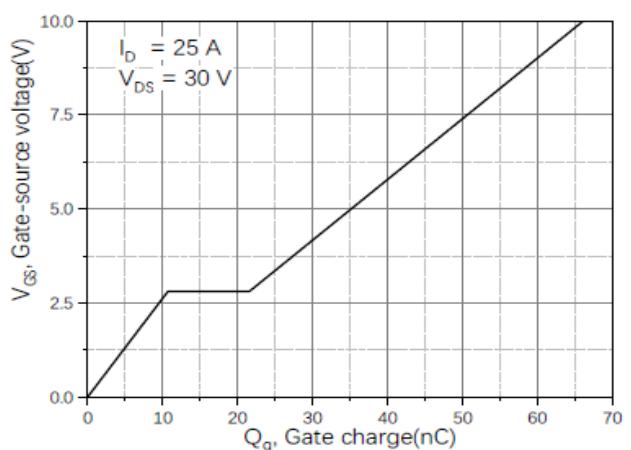


Figure 4, Typ. gate charge

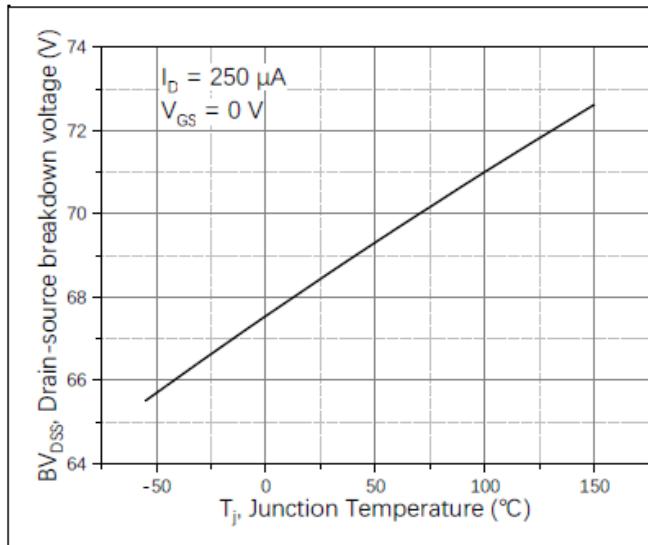


Figure 5, Drain-source breakdown voltage

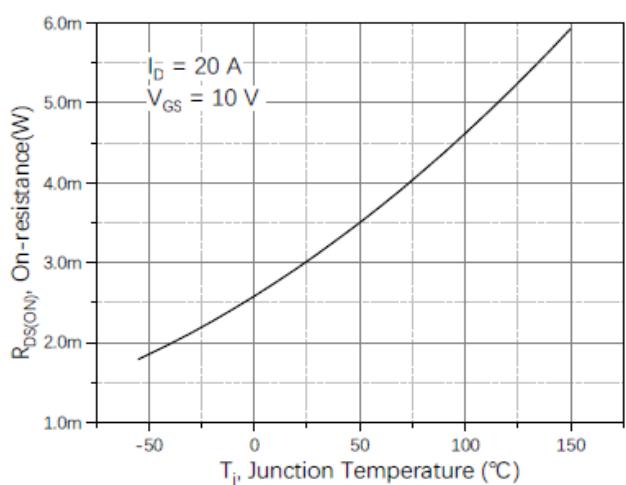


Figure 6, Drain-source on-state resistance

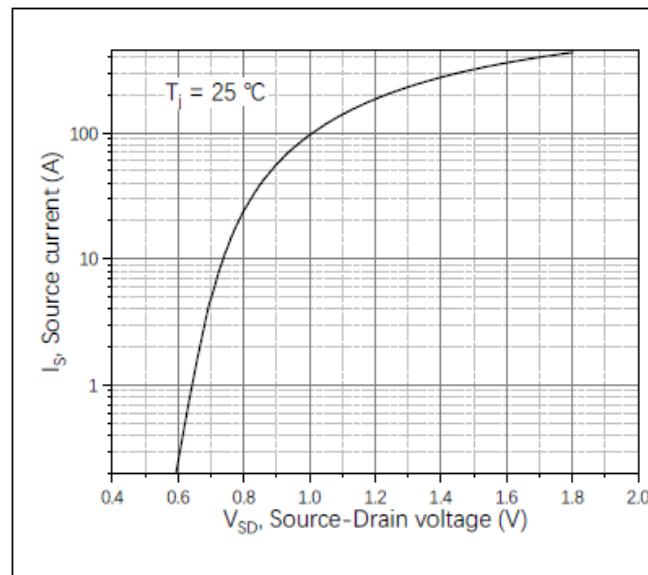


Figure 7, Forward characteristic of body diode

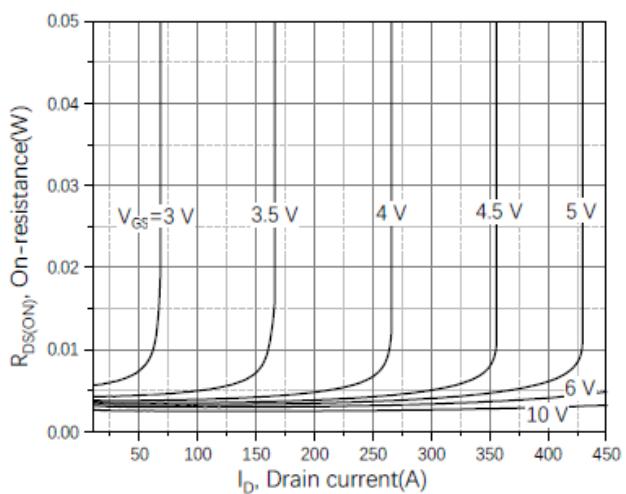
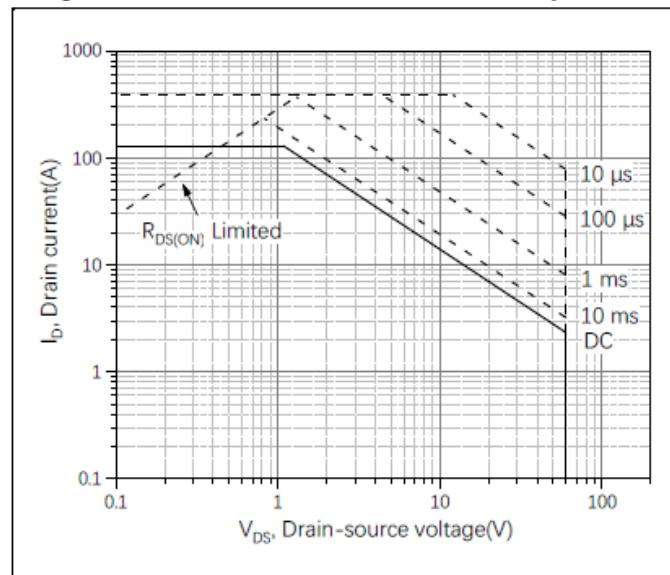


Figure 8, Drain-source on-state resistance

Figure 9, Safe operation area  $T_c=25 ^\circ C$ 

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